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Maintenance and Service Guide Compaq Notebook Evo N150 Series

Document Part Number: 238849-001

June 2001

This guide is a troubleshooting reference used for maintaining and servicing the notebook. It provides comprehensive information on identifying computer features, components, and spare parts, troubleshooting computer problems, and performing computer disassembly procedures. © 2001 Compaq Computer Corporation

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1

Product Description

1.1 Models and Features

The Compaq Notebook Evo N150 Series offer advanced modularity, Intel Pentium III and Intel Celeron processors with 64-bit architecture, industry-leading Accelerated Graphics Port (AGP) implementation, and extensive multimedia support.



Figure 1-1. Compaq Notebook Evo N150

Models

Computer models are shown in Table1-1.

Table 1-1
Compaq Notebook Evo N150
Models and Model Naming Conventions

Кеу												
N15	Р	800	T4X	15	V	С	64	8L	ME	XXXXXX-XXX		
1	2	3	4	5	6	7	8	9	10	11		
Key	Des	criptio	n		Ор	tions	i					
1	1 Brand / Series designator						N=Notebook			15=150		
2	Proc	cessor t	ype		P=I	ntel F	Pentiun	n III	C=In	tel Celeron		
3	Proc	cessor s	speed		800)=800) MHz		700=	700MHz		
4	Display type / size / resolution					T=TFT 4=14.x-inch			X=XGA (1024 × 768)			
5	Hard	d drive :	size		15=15.0 GB				10=10.0 GB			
6	Optical drive designator					V=8X Max DVD-ROM drive			D=24X Max CD-ROM drive W=CD-RW			
7	Integrated communication					M=modem 0=none				odem/NIC ombination card		
8	8 RAM					64=64 MB						
9	Battery cells / type					8L=8 cells, Lithium ion (Li ion)			9H=9 N (I) cells, Nickel /letal-Hydride NMH)		
10	Ope	rating s	system		ME=Windows Millennium Edition					lition		
11	SKL	J#			All bas	comp se SK	outer m U#.	odels	use 47	0013-XXX as the		
All computer models use configuration code JQKZ.												

Table 1-1 Compaq Notebook Evo N150 Models and Model Naming Conventions <i>(Continued)</i>									ntinued)	
1	2	3	4	5	6	7	8	9	10	11
N15	Ρ	800	T4X	15	V	С	64	8L	ME	470013-XXX
Belgiu	um	1	I	470	013-6	663	Norw	ay	1	470013-668
Czecł	n Rep	ublic		470013-735		Portu	Portugal		470013-748	
Denm	nark			470	013-6	664	Russ	ia		470013-749
Franc	е			470	013-7	737	Saud	i Arabi	а	470013-734
Frenc	h Can	ada		470	013-6	662	Slovakia / Slovenia			470013-669
Germ	any			470	013-7	739	Spain			470013-751
Greed	470013-665		Sweden / Finland			470013-670				
Hung	470013-741		Switzerland			470013-671 470013-672				
Israel		470	013-7	743	Turkey			470013-753		
Italy				470013-745			United Kingdom			470013-754
Korea	470013-674			United States			470013-661 470013-726			
The N	lether	lands		470013-747						
N15	Р	800	T4X	15	V	0	64	8L	ME	470013-XXX
Europe					1	1	1	1	1	470013-728
N15	Р	800	T4X	10	V	С	64	8L	ME	470013-XXX
Austra	470013-673 470013-727		Taiwan		1	470013-675				
Japar	470013-691 470013-693									

Table 1-1 Compaq Notebook Evo N150 Models and Model Naming Conventions <i>(Continued)</i>										
1	2	3	4	5	6	7	8	9	10	11
N15	С	700	T4X	15	D	С	64	8L	ME	470013-XXX
Taiwa	n	1	I				1			470013-659
N15	С	700	T4X	10	D	С	64	8L	ME	470013-XXX
Asia /	Pacif	ic	I	470	013-0	658	The I	Vether	lands	470013-713
Austra	alia			470	013-1	731	Norw	ay		470013-621
Belgiu	ım			470	013-0	619	Portu	igal		470013-714
Czecł	n Rep	ublic		470	013-1	701	Russ	ia		470013-718
Denmark				470013-620		Slovakia / Slovenia			470013-622	
Franc	е			470013-702		Spain			470013-719	
Germ	ermany 470013-703				703	Sweden / Finland			470013-623	
Hungary				470013-705		Switzerland			470013-624 470013-625	
Israel					470013-709		Turkey			470013-722
Italy				470	013-1	712	United Kingdom			470013-723
Japan 4 4			470 470	470013-684 470013-685		United States		es	470013-617 470013-660 470013-730	
N15	С	700	T4X	10	W	С	64	8L	ME	470013-XXX
Japan			470013-687		Taiwan			470013-688		
N15	С	700	T4X	10	D	С	64	9H	ME	470013-XXX
Frenc	h Can	ada		470	013-0	618	Saudi Arabia		a	470013-700
N15	С	700	T4X	10	D	0	64	9H	ME	470013-XXX
Europ	ean									470013-724

Features

- Processors, varying by computer model:
 - 800-MHz Intel Pentium III Processor with 256-KB integrated cache
 - 700-MHz Intel Celeron Processor with 128-KB integrated cache
- 64-MB high-performance Synchronous DRAM (SDRAM), expandable to 512 MB
- Integrated Trident CyberBlade i1 with AGP 2X support
- 14.1-inch, XVGA, TFT (1024 × 768) display, with over 16.8 million colors
- 15- or 10-GB high-capacity hard drive
- Full-size TouchPad keyboard
- Mini PCI 56K V.90 modem or optional Mini PCI V.90 modem plus 10/100 NIC combination card
- Support for two Type II PC Card slots with support for both 32-bit CardBus and 16-bit PC Cards
- Microsoft Windows Me, Windows 98, or Windows 2000 preinstalled
- External AC adapter with power cord
- 8-cell Lithium ion (Li ion) battery pack

- Connectors for:
 - □ RJ-11 modem
 - universal serial bus
 - □ stereo line out/headphone
 - parallel
 - serial
 - □ external keyboard/mouse
 - □ RJ-45 network
 - external monitor
 - \Box AC power
- Stereo speakers providing Compaq PremierSound 16-bit stereo sound

1.2 Clearing a Password

If the notebook you are servicing has an unknown password, follow these steps to clear the password. These steps also clear CMOS.

- 1. Prepare the computer for disassembly. Refer to Section 5.3, "Preparing the Computer for Disassembly," for more information.
- 2. Remove the RTC battery. Refer to Section 5.19, "Disk Cell Real Time Clock (RTC) Battery," for more information.
- 3. Wait approximately five minutes.

- 4. Replace the RTC battery and reassemble the computer.
- 5. Connect AC power to the computer. Do **not** reinsert any battery packs at this time.
- 6. Turn on the computer.

All passwords and all CMOS settings are clear.

1.3 Power Management

The computer comes with a collection of power management features that extend battery operating time and conserve power. The computer supports the following power management features:

- Standby
- Hibernation
- Smart battery that provides an accurate battery power gauge
- Battery calibration
- Lid switch suspend/resume
- Power button
- Advanced Configuration and Power Management (ACP) compliant

1.3 External Computer Components

The external components on the front and left side of the computer are shown in Figure 1-2 and described in Table 1-2.



Figure 1-2. Front and Left Side Components

Table 1-2 Front and Left Side Panel Components

Item	Component	Function				
1	Security cable slot	Attaches an optional security cable to the computer.				
2	Vent	Allows airflow to cool internal components. CAUTION: To prevent damage, the computer will shut down if a severe overheating condition occurs. To prevent loss of information, do not block the cooling vent. Avoid placing the computer on a blanket, rug, or other flexible surface that may cover the vent area.				

Table 1-2 Front and Left Side Panel Components (Continued)

Item	Component	Function
3	Air intake vent	Cools internal components.
4	RJ-11 jack (internal modem models only)	Connects the modem cable to an internal modem. A modem cable is included with internal modem models.
5	USB connector	Connects USB devices.
6	PC Card slots (2)	Support a 32-bit (CardBus) or 16-bit PC Card.
7	PC Card eject buttons	Eject a PC Card from a PC Card slot.
8	Stereo line-out/ headphone jack	Connects stereo speakers, headphones, headset, or television audio.
9	Stereo line-in jack	Connects a CD player, tuner, or tape deck.
10	Power light	On: Power is turned on. Blinking: Computer is in Standby. The power light also blinks if a battery pack that is the only available power source reaches a low-battery condition.
11	Battery light	On: A battery pack is charging. Blinking: A battery pack that is the only available power source has reached a low-battery condition.
12	Hard drive	Supports the removable primary hard drive. Two screws secure the hard drive to the computer.

The computer right side and rear panel components are shown in Figure 1-3 and described in Table 1-3.



Figure 1-3. Right Side and Rear Panel Components

Table 1-3Right Side and Rear Panel Components						
Item	Component	Function				
1	Media Bay	Accepts a diskette drive, CD- or DVD-ROM drive, or secondary battery pack.				
2	Infrared port	Links to another IrDA-compliant device for wireless communication.				

Table 1-3Right Side and Rear Panel Components (Continued)

Item	Component	Function
3	Parallel connector	Connects a parallel device.
4	Serial connector	Connects a serial device.
5	Keyboard/mouse connector	Connects an external keyboard or PS/2-compatible external mouse. To connect a keyboard and a mouse at the same time, use an optional Y-adapter.
6	RJ-45 jack (network models only)	Connects the network cable. A network cable is not included with the computer.
7	USB connectors	Connect USB devices.
8	External monitor connector	Connects an external monitor or overhead projector.
9	DC power jack	 Connects any one of the following items: AC Adapter Optional Automobile Power Adapter/Charger Optional Aircraft Power Adapter

The keyboard components are shown in Figure 1-4 and described in Table 1-4.



Figure 1-4. Keyboard Components

Table 1-4Keyboard Components

Item	Component	Function
1	F1 through F12 function keys	Perform preset functions.
2	Embedded numeric keypad	Converts keys to numeric keypad.
3	Cursor control keys	Move the cursor around the screen.
4	Windows application key	Displays a menu when using a Microsoft application. The menu is the same that is displayed by pressing the right mouse button.
5	Windows logo key	Displays the Windows Start menu.
6	Fn key	Used with hotkeys to perform preset hotkey functions.
7	Caps lock key	Turns on the caps lock function.

The components on the top of the computer are shown in Figure 1-5 and described in Table 1-5.



Figure 1-5. Top Components

Table 1-5 Top Components		
Item	Component	Function
1	Power button	Turns on the computer. To turn off the computer, use the operating system Shut Down command.
2	Drive light indicator	Turns on when the hard drive, CD-, or DVD-ROM drive is accessed.

Top Components (Continued)		
Item	Component	Function
3	Diskette drive light	Turns on when the diskette drive in the Media Bay or the optional external diskette drive is accessed.
4	Num lock light	On: Num lock is on and the embedded numeric keypad is enabled.
5	Caps lock light	On: Caps lock is on.
6	Scroll lock light	On: Scroll is on.
7	Microphone	Inputs single-channel sound to the computer; can be used whether the computer is open or closed.
8	Easy Access buttons (4)	Four buttons that provide quick access to the Internet. Refer to the <i>Hardware Guide</i> that ships with the computer for information about these buttons.
9	Stereo speakers (2)	Produce stereo sound.
10	Right TouchPad button	Functions like the right mouse button on an external mouse.
11	TouchPad	Moves the mouse cursor, selects, and activates.
12	Left TouchPad button	Functions like the left mouse button on an external mouse.

Table 1-5 Top Components (Continued)

The external components on the bottom of the computer are shown in Figure 1-6 and described in Table 1-6.



Figure 1-6. Bottom Components

Table 1-6 Bottom Components

	Component	Function
1	Media Bay release latch	Releases the Media Bay device from the connector.
2	Serial number	Identifies the computer; needed when you call Compaq customer support.

Bottom Components (Continued)		
	Component	Function
3	Reset button	Manually resets the system if a failure occurs. MARNING: Resetting the computer will cause unsaved information to be lost. Before performing a reset, close all applications and shut down Windows, if possible.
4	Fan	Provides airflow to cool internal components.
5	Memory expansion compartment cover	Covers the memory expansion compartment that contains two memory expansion slots for memory expansion boards.
6	Hard drive	Removable primary hard drive. Two screws secure the hard drive to the computer.
7	Battery security latch	Secures the battery pack in the battery compartment.
8	Battery release latch	Releases the battery pack from the battery compartment.
9	Battery compartment	Holds the primary battery pack.
10	Media Bay	Accepts a diskette drive, CD- or DVD-ROM drive, or secondary battery pack.

Table 1-6Bottom Components (Continued)

1.4 Design Overview

This section presents a design overview of key parts and features of the computer. Refer to Chapter 3, "Illustrated Parts Catalog," to identify replacement parts, and Chapter 5, "Removal and Replacement Procedures," for disassembly steps. The system board provides the following device connections:

- Memory expansion board
- Hard drive
- Display
- Keyboard/TouchPad or pointing stick
- Audio
- Intel Pentium III or Celeron processors
- Fan
- PC Card
- Modem or modem/NIC

The computer uses an electrical fan for ventilation. The fan is controlled by a temperature sensor and is designed to turn on automatically when high temperature conditions exist. These conditions are affected by high external temperatures, system power consumption, power management/battery conservation configurations, battery fast charging, and software applications. Exhaust air is displaced through the ventilation grill located on the right side of the computer.

CAUTION: To properly ventilate the computer, allow at least a 3-inch (7.6-cm) clearance on the left and right sides of the computer.

Troubleshooting



WARNING: Only authorized technicians trained by Compaq should repair this equipment. All troubleshooting and repair procedures are detailed to allow only subassembly/module level repair. Because of the complexity of the individual boards and subassemblies, no one should attempt to make repairs at the component level or to make modifications to any printed wiring board. Improper repairs can create a safety hazard. Any indication of component replacement or printed wiring board modification may void any warranty or exchange allowances.

Utilities that are preinstalled on the computer include:

- PhoenixBIOS Setup Utility—Allows you to modify or restore factory default settings and configure the system BIOS to diagnose and solve minor problems.
- Power Management—Allows you to reduce your computer power consumption. Power Management information is contained in Chapter 1.
- Security—Allows you to set or remove your power-on password.

Using the PhoenixBIOS Setup Utility

The PhoenixBIOS Setup Utility (PSU) is built into the system. You can configure the system BIOS and modify or restore factory default settings, such as date and time, types of disk drives, power management, and password settings. To run PSU, press **F10** during system startup. When the main screen displays, use the keyboard and arrow keys to move around the menus and make selections.

Troubleshooting Flowcharts

	······································
Section	Description
2.1	Initial troubleshooting
2.2	No power, part 1
2.3	No power, part 2
2.4	No power, part 3
2.5	No power, part 4
2.6	No video, part 1
2.7	No video, part 2
2.8	Non functioning docking station
2.9	No operating system (OS) loading
2.10	No OS loading from hard drive, part 1
2.11	No OS loading from hard drive, part 2
2.12	No OS loading from hard drive, part 3
2.13	No OS loading from diskette drive
2.14	No OS loading from CD- or DVD-ROM drive
2.15	No audio, part 1
2.16	No audio, part 2
2.17	Non functioning device
2.18	Non functioning keyboard
2.19	Non functioning pointing device
2.20	No network or modem connection

Table 2-1 Troubleshooting Flowcharts Overview



2.1 Initial Troubleshooting



2.3 No Power, Part 2



2.4 No Power, Part 3











2.8 Non Functioning Docking Station (if applicable)



2.9 No Operating System (OS) Loading


2.10 No OS Loading from Hard Drive, Part 1



2.11 No OS Loading from Hard Drive, Part 2



2.12 No OS Loading from Hard Drive, Part 3











Maintenance and Service Guide



2.18 Non Functioning Keyboard







2.20 Network or Modem Connection

Illustrated Parts Catalog

This chapter provides an illustrated parts breakdown and a reference for spare part numbers.

3.1 Serial Number Location

When ordering parts or requesting information, provide the computer serial number and model number located on the bottom of the computer (Figure 3-1).



Figure 3-1. Serial Number Location

3.2 Computer System Major Components



Figure 3-2. Computer System Major Components

Table 3-1
Computer System Major Components

Item	Description			Spare Part Number
1	14.1-inch, XGA,	CTFT display		239029-001
	Miscellaneous I	Plastics Kit		239039-001
2a 2b	Left hinge cove Right hinge co	er ver	Not Illustrated: Computer feet PC Card doors Hard drive bezel	
	Keyboard			
3	Czech Danish European French French Canadian German Hebrew Hungarian International Italian Japanese	239054-221 239054-081 239054-021 239054-051 239054-041 239054-041 239054-8B1 239054-211 239054-002 239054-061 239054-291	Korean Norwegian Portuguese Russian Spanish Swedish Swiss Taiwanese Turkish U.K. English U.S. English	239054-AD1 239054-091 239054-131 239054-251 239054-071 239054-101 239054-111 239054-AB1 239054-031 239054-001
	Miscellaneous I	Hardware Kit		239052-001
4a 4b 4c	EMI shield TouchPad bracket Memory expansion compartment cover			
5	Top cover			239044-001
	Cable Kit			239041-001
6a 6b 6c	Display lid swit Microphone Modem conne	tch board ctor/cable		



Computer System Major Components (continued)

Table 3-1 Computer System Major Components (Continued)			
Item	Description	Spare Part Number	
	Speakers	239043-001	
7a 7b	Left speaker Right speaker		
8	TouchPad (TouchPad bracket included in Hardware Kit, spare part number 239052-001)	239046-001	
9	Heat sink	239038-001	
10	PC Card assembly	239040-001	
11	Hard drives		
	15 GB 10 GB	239037-001 239036-001	
12	System boards (includes 64 MB SDRAM)		
	800 MHz Intel Pentium III 700 MHz Intel Celeron	239051-001 239050-001	
13	Disk cell RTC battery	236359-001	
14	Infrared board	239045-001	



Computer System Major Components (continued)

Table 3-1 Computer System Major Components (Continued)			
Item	Description	Spare Part Number	
15	Mini PCI Communications Boards		
	Type III mini PCI combination 56 Kbps modem/NIC board Type III mini PCI 56 Kbps modem board	233558-001 233557-001	
16	Media Bay devices		
	Diskette drive 24X Max CD-ROM drive CD-RW drive 8X Max DVD-ROM drive	239035-001 239033-001 239034-001 239032-001	
17	Base enclosure	239031-001	
18	Battery packs		
	8-cell Lithium ion (Li ion)	231962-001	

···· /	
8-cell Lithium ion (Li ion)	231962-001
6-cell Lithium ion (Li ion)	231963-001

3.3 Miscellaneous Plastics Kit Components



Figure 3-3. Miscellaneous Plastics Kit Components

Table 3-2 Miscellaneous Plastics Kit Components Spare Part Number 239039-001

Item	Description
1	Left hinge cover
2	Right hinge cover
3	PC Card doors
4	Computer feet
5	Hard drive bezel

3.4 Miscellaneous Hardware Kit Components



Figure 3-4. Miscellaneous Hardware Kit Components

Table 3-3 Miscellaneous Hardware Kit Components Spare Part Number 239052-001

Item	Description
1	Memory expansion compartment cover
2	TouchPad bracket
3	EMI shield

3.5 Cable Kit Components







Figure 3-5. Cable Kit Components

Table 3-4Cable Kit ComponentsSpare Part Number 239041-001

Item	Description
1	Microphone
2	Display lid switch board
3	Modem connector/cable

3.6 Mass Storage Devices



Figure 3-6. Mass Storage Devices

	Table 3	-5
Mass	Storage	Devices

Item	Description	Spare Part Number
1	Diskette drive	239035-001
2	Hard drives	
	15 GB 10 GB	239037-001 239036-001
3	Optical drives	
	24X Max CD-ROM drive CD-RW drive 8X Max DVD-ROM drive	239033-001 239034-001 239032-001

3.7 Miscellaneous

Table 3-6Miscellaneous Spare Parts (not illustrated)			
Description			Spare Part Number
Modems			
Type III mini PCI co Type III mini PCI 56	mbination 56 Kbps n Kbps modem board	nodem/NIC board	233558-001 233557-001
Modem adapters			
Czech	234963-221	Norwegian	234963-091
German	236432-041	Swiss	198294-111
Hungarian	234963-211		
Modem cable			234962-001
Modem cable adapte	rs		
Australian			304398-011
Belgian			304398-181
French			304398-051
RJ-11 P55 adapters			
Danish	316904-081	Italian	316904-061
Finnish	316904-351	Swedish	316904-101
RJ-11 PTT adapter (used in the United Kingdom)			158593-031
RJ-45 network cable			239049-001

Table 3-6 Miscellaneous Spare Parts (not illustrated) (Continued)				
Description			Spare Part Number	
External AC adapter			163444-001	
50W slim AC adapter			163444-291	
Logo kit			233556-001	
Memory expansion boa	ırds			
256 MB			167136-001	
128 MB			135244-001	
64 MB			135243-001	
Screw kit (Includes the screws and screwlock listed below. Refer to Appendix C, "Screw Listing," for more information about screw specifications and usage.) ■M2.5 × 8 ■M2 × 14.5 ■M1 × 4			239042-001	
■M2.5 × 7	■M2 × 12.5	■5.0 mm screwlock		
■M2.5 × 4.5	■M2 × 6			
■M2.5 × 3	■M2 × 5.5 ■M2 × 5 ■M2 × 4			
Power cord, black, 6 fee	et			
Australian Danish European/Middle	246959-011 246959-081	Korean Swiss Taiwanese	246959-AD1 246959-AG1 234961-AA1	
Eastern/African	246959-021	U.K. English	246959-031	
Italian	246959-061	U.S. English	246959-001	
Japanese	197233-001			

4

Removal and Replacement Preliminaries

This chapter provides essential information for proper and safe removal and replacement service.

4.1 Tools Required

You will need the following tools to complete the removal and replacement procedures:

- Magnetic screwdriver
- Phillips P0 screwdriver
- 5 mm socket
- Tool kit (includes connector removal tool, loopback plugs, and case utility tool)

4.2 Service Considerations

The following sections include some of the considerations that you should keep in mind during disassembly and assembly procedures.

As you remove each subassembly from the computer, place the subassembly (and all accompanying screws) away from the work area to prevent damage.

Plastic Parts

Using excessive force during disassembly and reassembly can damage plastic parts. Use care when handling the plastic parts. Apply pressure only at the points designated in the maintenance instructions.

Cables and Connectors

Cables must be handled with extreme care to avoid damage. Apply only the tension required to unseat or seat the cables during removal and insertion. Handle cables by the connector whenever possible. In all cases, avoid bending, twisting, or tearing cables. Ensure that cables are routed in such a way that they cannot be caught or snagged by parts being removed or replaced. Handle flex cables with extreme care; these cables tear easily.



CAUTION: When servicing the computer, ensure that cables are placed in their proper locations during the reassembly process. Improper cable placement can damage the computer.

4.3 Preventing Damage to Removable Drives

Removable drives are fragile components that must be handled with care. To prevent damage to the computer, damage to a removable drive, or loss of information, observe the following precautions:

- Before removing or inserting a hard drive, shut down the computer. If you are unsure whether the computer is off or in Hibernation, turn the computer on, then shut it down.
- Before removing a diskette drive or optical drive, ensure that a diskette or disc is not in the drive. Ensure that the optical drive tray is closed.

- Before handling a drive, ensure that you are discharged of static electricity. While handling a drive, avoid touching the connector.
- Handle drives on surfaces that have at least one inch of shock-proof foam.
- Avoid dropping drives from any height onto any surface.
- After removing a hard drive, CD-ROM drive, or a diskette drive, place it into a static-proof bag.
- Avoid exposing a hard drive to products that have magnetic fields such as monitors or speakers.
- Avoid exposing a drive to temperature extremes or to liquids.
- If a drive must be mailed, place the drive into a bubble pack mailer or other suitable form of protective packaging and label the package "Fragile: Handle With Care."

4.4 Preventing Electrostatic Damage

Many electronic components are sensitive to electrostatic discharge (ESD). Circuitry design and structure determine the degree of sensitivity. Networks built into many integrated circuits provide some protection, but in many cases the discharge contains enough power to alter device parameters or melt silicon junctions.

A sudden discharge of static electricity from a finger or other conductor can destroy static-sensitive devices or microcircuitry. Often the spark is neither felt nor heard, but damage occurs. An electronic device exposed to electrostatic discharge may not be affected at all and can work perfectly throughout a normal cycle. The device may function normally for awhile, then degrade in the internal layers, reducing its life expectancy.

4.5 Packaging and Transporting Precautions

Use the following grounding precautions when packaging and transporting equipment:

- To avoid hand contact, transport products in static-safe containers such as tubes, bags, or boxes.
- Protect all electrostatic-sensitive parts and assemblies with conductive or approved containers or packaging.
- Keep electrostatic-sensitive parts in their containers until the parts arrive at static-free workstations.
- Place items on a grounded surface before removing items from their containers.
- Always be properly grounded when touching a sensitive component or assembly.

- Place reusable electrostatic-sensitive parts from assemblies in protective packaging or non conductive foam.
- Use transporters and conveyers made of antistatic belts and roller bushings. Ensure that mechanized equipment used for moving materials is wired to ground and that proper materials were selected to avoid static charging. When grounding is not possible, use an ionizer to dissipate electric charges.

4.6 Workstation Precautions

Use the following grounding precautions at workstations:

- Cover the workstation with approved static-dissipative material (refer to Table 4-2).
- Use a wrist strap connected to a properly grounded work surface and use properly grounded tools and equipment.
- Use conductive field service tools, such as cutters, screwdrivers, and vacuums.
- When using fixtures that must directly contact dissipative surfaces, only use fixtures made of static-safe materials.
- Keep the work area free of nonconductive materials such as ordinary plastic assembly aids and Styrofoam.
- Handle electrostatic-sensitive components, parts, and assemblies by the case or PCM laminate. Handle these items only at static-free workstations.
- Avoid contact with pins, leads, or circuitry.
- Turn off power and input signals before inserting or removing connectors or test equipment.

4.7 Grounding Equipment and Methods

Grounding equipment must include either a wrist strap or a foot strap at a grounded workstation.

- When seated, wear a wrist strap connected to a grounded system. Wrist straps are flexible straps with a minimum of one megaohm ±10% resistance in the ground cords. To provide proper ground, wear a strap snugly against the skin at all times. On grounded mats with banana-plug connectors, connect a wrist strap with alligator clips.
- When standing, use foot straps and a grounded floor mat. Foot straps (heel, toe, or boot straps) can be used at standing workstations and are compatible with most types of shoes or boots. On conductive floors or dissipative floor mats, use foot straps on both feet with a minimum of one-megaohm resistance between the operator and ground. To be effective, the conductive strips must be worn in contact with the skin.

Other grounding equipment recommended for use in preventing electrostatic damage includes:

- Antistatic tape
- Antistatic smocks, aprons, and sleeve protectors
- Conductive bins and other assembly or soldering aids
- Non-conductive foam
- Conductive tabletop workstations with ground cords of one-megaohm resistance
- Static-dissipative table or floor mats with hard tie to ground
- Field service kits
- Static awareness labels
- Material-handling packages

- Non-conductive plastic bags, tubes, or boxes
- Metal tote boxes
- Electrostatic voltage levels and protective materials

Table 4-1

Table 4-1 shows how humidity affects the electrostatic voltage levels generated by different activities.

Typical Electrostatic Voltage Levels					
	Relative Humidity				
Event	10%	40%	55%		
Walking across carpet	35,000 V	15,000 V	7,500 V		
Walking across vinyl floor	12,000 V	5,000 V	3,000 V		
Motions of bench worker	6,000 V	800 V	400 V		
Removing DIPS from plastic tube	2,000 V	700 V	400 V		
Removing DIPS from vinyl tray	11,500 V	4,000 V	2,000 V		
Removing DIPS from Styrofoam	14,500 V	5,000 V	3.500 V		
Removing bubble pack from PCB	26,500 V	20,000 V	7,000 V		
Packing PCBs in foam-lined box	21,000 V	11,000 V	5,000 V		
A product can be degraded by as little as 700 volts.					

Table 4-2 lists the shielding protection provided by antistatic bags and floor mats.

Table 4-2 Static-Shielding Materials

Material	Use	Voltage Protection Level
Antistatic plastic	Bags	1,500 V
Carbon-loaded plastic	Floor mats	7,500 V
Metallized laminate	Floor mats	5,000 V

5

Removal and Replacement Procedures

This chapter provides removal and replacement procedures.

All screws removed during disassembly are P0 Phillips screws. There are 64 screws and screwlocks in 13 different sizes that must be removed and replaced when servicing the computer. Make special note of each screw size and location during removal and replacement.

Refer to Appendix C, "Screw Listing," for detailed information on screw sizes, locations, and usage.

5.1 Serial Number

Report the computer serial number to Compaq when requesting information or ordering spare parts. The serial number is located on the bottom of the computer (Figure 5-1).



Figure 5-1. Serial Number Location

5.2 Disassembly Sequence Chart

Use the following chart to determine the section number to be referenced when removing computer components.

Table 5 1

Disassembly Sequence Chart			
Section	Description	# of Screws Removed	
5.3	Preparing the computer for disassembly	0	
5.4	Computer feet	0	
5.5	Hinge covers	0	
5.6	Keyboard	2	
5.7	Display	4	
5.8	EMI shield	1	
5.9	Top cover	18	
5.10	TouchPad	5	
5.11	Speakers	10	
5.12	Microphone	0	
5.13	Display lid switch board	1	
5.14	Heat sink	5	
5.15	Infrared board	1	
5.16	System board	11	
5.17	PC Card assembly	2	
5.18	Mini PCI board	0	
5.19	Disk cell real time clock (RTC) battery	0	

Maintenance and Service Guide

5.3 Preparing the Computer for Disassembly

Perform the following steps before disassembling the computer. Consult the computer *Hardware Guide* for instructions on the following steps:

- 1. Turn off the computer.
- 2. Disconnect the AC Adapter and all external devices.
- 3. Remove the battery pack.
- 4. Remove the hard drive.
- 5. Remove the Media Bay device.

5.4 Computer Feet

The computer feet are adhesive-backed rubber pads. The computer feet are included in the Miscellaneous Plastics Kit (spare part number 239039-001). Refer to Figure 5-2 for the computer feet locations.



Figure 5-2. Replacing the Computer Feet

5.5 Hinge Covers

The hinge covers are included in the Miscellaneous Plastics Kit (spare part number 239039-001).

- 1. Prepare the computer for disassembly (Section 5.3).
- 2. Turn the computer top side up with the front facing you.
- 3. Open the computer.
- 4. Use a flat blade screwdriver to pry up on the front edge of the left and right ② hinge covers (Figure 5-3).



Figure 5-3. Removing the Hinge Covers

5. Remove the hinge covers.

Reverse the above procedure to install the hinge covers.
5.6 Keyboard

Keyboard Cover Spare Part Number Information			
Keyboard			
Czech	239054-221	Korean	239054-AD1
Danish	239054-081	Norwegian	239054-091
European	239054-021	Portuguese	239054-131
French	239054-051	Russian	239054-251
French Canadian	239054-121	Spanish	239054-071
German	239054-041	Swedish	239054-101
Hebrew	239054-BB1	Swiss	239054-111
Hungarian	239054-211	Taiwanese	239054-AB1
International	239054-002	Turkish	239054-141
Italian	239054-061	U.K. English	239054-031
Japanese	239054-291	U.S. English	239054-001

- 1. Prepare the computer for disassembly (Section 5.3).
- 2. Remove the hinge covers (Section 5.5).

- 3. Remove the two pewter M2.5 \times 7.0 screws **1** that secure the keyboard to the top cover (Figure 5-4).
- 4. Lift up the back edge of the keyboard and swing it up and forward ② until it rests on the top cover.
- 5. Release the zero insertion force (ZIF) connector ③ to which the keyboard cable is connected and disconnect the keyboard cable ④.



Figure 5-4. Removing the Keyboard

6. Remove the keyboard.

Reverse the above procedure to install the keyboard.

5.7 Display

Display Spare Part Number Information

14.1-inch, XGA, CTFT display

239029-001

When the display screws are removed, the display assembly is unsupported. Make sure to provide support for the display assembly when removing the display screws.

- 1. Prepare the computer for disassembly (Section 5.3).
- 2. Remove the hinge covers (Section 5.5).
- 3. Disconnect the display cable **1** from the system board (Figure 5-5).
- 4. Remove the four silver M2.5 \times 8.0 screws 2 that secure the display to the base enclosure.



Figure 5-5. Removing the Display

5. Remove the display.

To ensure proper alignment of the display during replacement, loosely install the screws in the **1**, **2**, **3**, **4** sequence indicated in Figure 5-6. Tighten the screws after all four have been been loosely installed.

After tightening the display screws, tuck the display cable into the slot **③** in the base enclosure.



Figure 5-6. Installing the Display Screws

Reverse the above procedure to install the display.

5.8 EMI Shield

The EMI shield is included in the Miscellaneous Hardware Kit (spare part number 239052-001).

- 1. Prepare the computer for disassembly (Section 5.3) and remove the following components:
 - a. Hinge covers (Section 5.5)
 - b. Keyboard (Section 5.6)
 - c. Display (Section 5.7)
- 2. Remove the black M2 \times 12.5 screw **①** that secures the EMI shield to the base enclosure (Figure 5-7).
- Lift the back edge of the EMI shield up and swing it forward ②, then slide the EMI shield toward the back of the computer at a 45-degree angle ③.
- 4. Remove the EMI shield.



Figure 5-7. Removing the EMI Shield

Reverse the above procedure to install the EMI shield.

5.9 Top Cover

Top Cover Spare Part Number Information

Top cover

239044-001



There are 18 screws in three different sizes that must be removed and replaced during replacement of the top cover. Make special note of each screw size and location when removing and replacing screws.

- 1. Prepare the computer for disassembly (Section 5.3) and remove the following components:
 - a. Hinge covers (Section 5.5)
 - b. Keyboard (Section 5.6)
 - c. Display (Section 5.7)
 - d. EMI shield (Section 5.8)
- 2. Turn the computer bottom side up with the rear panel facing you.

- 3. Remove the following screws:
 - □ Nine pewter M2.5 × 7.0 screws from the recesses in the bottom of the computer **①** (Figure 5-8)
 - □ Two black M2.5 × 4.5 screws ② from the bottom of the computer
 - One silver M2 \times 5.5 screw **③** from the battery bay
 - □ Three black M2.5 × 4.5 screws ④ from the rear panel of computer



Figure 5-8. Removing the Top Cover Screws

- 4. Turn the computer top side up with the front facing you.
- Disconnect the display lid switch board ①, microphone ②, and right ③ and left ④ speaker cables (Figure 5-9).
- 6. Release the ZIF connector **⑤** to which the TouchPad cable is connected and disconnect the TouchPad cable **⑥**.



Figure 5-9. Disconnecting Top Cover Connectors

- 7. Remove the two pewter M2.5 × 7.0 screws and the black M2.5 × 4.5 screw that secure the top cover to the base enclosure (Figure 5-10).
- 8. Lift the back edge of the top cover ③ and swing it up and forward.



Figure 5-10. Removing the Top Cover

9. Remove the top cover.

Reverse the above procedure to install the top cover.

5.10 TouchPad

TouchPad Spare Part Number Information			
TouchPad TouchPad	Bracket (included in Miscellaneous Hardware Kit)	239046-001 239052-001	
1.	Prepare the computer for disassembly (Section remove the following components:	n 5.3) and	
	a. Hinge covers (Section 5.5)		
	b. Keyboard (Section 5.6)		
	c. Display (Section 5.7)		
	d. EMI shield (Section 5.8)		
	e. Top cover (Section 5.9)		
2.	Turn the top cover bottom side up with the fro	nt facing you.	

3. Remove the two silver M2.5 × 3.0 screws **①** and the three black M2.5 × 4.0 screws **②** that secure the TouchPad bracket and TouchPad to the top cover (Figure 5-11).



Figure 5-11. Removing the TouchPad Screws

- 4. Release the ZIF connector **1** to which the TouchPad cable is attached and disconnect the TouchPad cable **2** (Figure 5-12).
- 5. Slide the TouchPad bracket **③** toward the back of the top cover.
- 6. Remove the TouchPad bracket ④ and TouchPad ⑤ from the top cover.



Figure 5-12. Removing the TouchPad

Reverse the above procedure to install the TouchPad.

5.11 Speakers

Speakers Spare Part Number Information			
Speakers	239043-001		
1.	Prepare the computer for disassembly (Section 5.3) and remove the following components:		
	a. Hinge covers (Section 5.5)		
	b. Keyboard (Section 5.6)		
	c. Display (Section 5.7)		
	d. EMI shield (Section 5.8)		
	e. Top cover (Section 5.9)		
2.	Turn the top cover bottom side up with the front facing you.		

- 3. Remove the two M2.5 \times 4.5 screws **0** that secure the top cover shield to the top cover (Figure 5-13).
- 4. Remove the right speaker cable from the clips **2** and **3** in the top cover shield.



Figure 5-13. Routing the Speaker Cables

- 5. Remove the eight silver M2 \times 5.5 screws **1** that secure the speakers to the top cover (Figure 5-14).
- 6. Remove the speakers from the top cover \boldsymbol{Q} .



Figure 5-14. Removing the Speakers

Reverse the above procedure to install the speakers.



The left and right speakers are not interchangeable. The right speaker has a longer speaker cable and must be installed in the right speaker position.

5.12 Microphone

The microphone is included in the Cable Kit (spare part number 239041-001).

- 1. Prepare the computer for disassembly (Section 5.3) and remove the following components:
 - a. Hinge covers (Section 5.5)
 - b. Keyboard (Section 5.6)
 - c. Display (Section 5.7)
 - d. EMI shield (Section 5.8)
 - e. Top cover (Section 5.9)
- 2. Turn the top cover bottom side up with the front facing you.

- 3. Remove the microphone from the slot **1** in which it rests in the top cover (Figure 5-15).
- 4. Remove the microphone cable from the top cover slot **2** through which it is routed.
- 5. Turn the top cover top side up.
- 6. Remove the microphone cable from the clip **③** in which it rests in the top cover shield.



Figure 5-15. Removing the Microphone

Reverse the above procedure to install the microphone.

5.13 Display Lid Switch Board

The display lid switch board is included in the Cable Kit (spare part number 239041-001).

- 1. Prepare the computer for disassembly (Section 5.3) and remove the following components:
 - a. Hinge covers (Section 5.5)
 - b. Keyboard (Section 5.6)
 - c. Display (Section 5.7)
 - d. EMI shield (Section 5.8)
 - e. Top cover (Section 5.9)
- 2. Turn the top cover bottom side up with the front facing you.
- 3. Remove the silver M1 \times 4.0 screw **①** that secures the display lid switch board to the top cover (Figure 5-16).
- 4. Remove the display lid switch board **2** from the top cover.



Figure 5-16. Removing the Display Lid Switch Board

Reverse the above procedure to install the display lid switch board.

5.14 Heat Sink

The heat sink assembly includes the fan. The fan should not be removed from the heat sink assembly.

Heat Sink Spare Part Number Information			
Heat sink	239038-001		
1.	Prepare the computer for disassembly (Section 5.3) and remove the following components:		
	a. Hinge covers (Section 5.5)		
	b. Keyboard (Section 5.6)		
	c. Display (Section 5.7)		
	d. EMI shield (Section 5.8)		
	e. Top cover (Section 5.9)		

- 2. Disconnect the fan cable **1** from the system board (Figure 5-17).
- 3. Remove the modem cable from the clip in the heat sink $\boldsymbol{2}$.
- Remove the four black M2 × 4.0 screws € and the pewter M2.5 × 7.0 screw € that secure the heat sink to the base enclosure.
- 5. Remove the heat sink.



Figure 5-17. Removing the Heat Sink

The fan and heat sink are spared as one assembly. Do not remove the fan from the heat sink.

Reverse the above procedure to install the heat sink.

5.15 Infrared Board

Infrared Board Spare Part Number Information			
Infrared bo	ard		239045-001
1.	Pre ren	epare the computer for disassembly (Section 5 nove the following components:	5.3) and
	a.	Hinge covers (Section 5.5)	
	b.	Keyboard (Section 5.6)	
	c.	Display (Section 5.7)	
	d.	EMI shield (Section 5.8)	
	e.	Top cover (Section 5.9)	

- 2. Disconnect the infrared board cable **1** from the system board (Figure 5-18).
- 3. Remove the infrared board cable from the metal clip **2** through which it is routed.
- 4. Remove the black $M2 \times 4.0$ screw **③** that secures the infrared board to the base enclosure.
- 5. Lift the infrared board **4** out of the base enclosure.



Figure 5-18. Removing the Infrared Board

Reverse the above procedure to install the infrared board.

5.16 System Board

There are 11 screws and screwlocks in five different sizes that must be removed and replaced when replacing the system board. Make special note of each screw size and location when removing and replacing screws.

System Board Spare Part Number Information

System boards (includes 64 MB SDRAM)

800 MHz Intel Pentium III	239051-001
700 MHz Intel Celeron	239050-001

- 1. Prepare the computer for disassembly (Section 5.3) and remove the following components:
 - a. Hinge covers (Section 5.5)
 - b. Keyboard (Section 5.6)
 - c. Display (Section 5.7)
 - d. EMI shield (Section 5.8)
 - e. Top cover (Section 5.9)
 - f. Infrared board (Section 5.15)
- 2. Turn the base enclosure top side up with the rear panel facing you.

3. Remove the six 5.0-mm screwlocks from the rear panel of the computer (Figure 5-19).



Figure 5-19. Removing the System Board Screwlocks

- 4. Position the base enclosure so the front faces you.
- 5. Remove the following screws, as illustrated in Figure 5-20:
 - □ two black M2 × 14.5 screws **①** that secure the PC Card assembly to the base enclosure
 - □ black M2.5 × 4.5 screw ② near the USB connector that secures the system board to the base enclosure
 - □ black M2.5 × 4.0 screw **③** that secures the modem connector/cable to the base enclosure
 - □ black M2 × 4.0 screw ④ near the display connector that secures the system board to the base enclosure



Figure 5-20. Removing the System Board Screws

6. Lift up the front edge of the system board **①** until the board and the battery connector **②** are clear of the base enclosure (Figure 5-21).

CAUTION: When removing the system board, make sure the battery connector **@** is carefully routed out of the opening **@** in the base enclosure in which it rests. Failure to follow this caution can result in damage to the battery connector.



Figure 5-21. Lifting the System Board

7. Slide the system board out of the base enclosure at an angle (Figure 5-22).



Figure 5-22. Removing the System Board

Reverse the above procedure to install the system board.

5.17 PC Card Assembly

PC Card Assembly Spare Part Number Information

PC Card assembly	239040-001

- 1. Prepare the computer for disassembly (Section 5.3)) and remove the following components:
 - a. Hinge covers (Section 5.5)
 - b. Keyboard (Section 5.6)
 - c. Display (Section 5.7)
 - d. EMI shield (Section 5.8)
 - e. Top cover (Section 5.9)
 - f. Infrared board (Section 5.15)
 - g. System board (Section 5.16)
- 2. Turn the system board bottom side up with the PC Card slot opening facing you.

- 3. Peel back the shielding tape that covers the right PC Card screw **●** (Figure 5-23).
- 4. Remove the two silver $M2 \times 5.0$ screws **2** that secure the PC Card assembly to the system board.
- 5. Turn the system board top side up with the PC Card slot opening facing you.
- 6. Lift up the back edge of the PC Card assembly to disconnect it from the system board **③**.
- 7. Remove the PC Card assembly.



Figure 5-23. Removing the PC Card Assembly

Reverse the above procedure to install the PC Card assembly.

5.18 Mini PCI Board

Mini PCI Board Spare Part Number Information

Mini PCI boards

Type III mini PCI combination 56 Kbps modem/NIC board	233558-001
Type III mini PCI 56 Kbps modem board	233557-001

- 1. Prepare the computer for disassembly (Section 5.3) and remove the following components:
 - a. Hinge covers (Section 5.5)
 - b. Keyboard (Section 5.6)
 - c. Display (Section 5.7)
 - d. EMI shield (Section 5.8)
 - e. Top cover (Section 5.9)
 - f. Infrared board (Section 5.15)
 - g. System board (Section 5.16)
- 2. Turn the system board bottom side up with the rear panel facing you.

- 3. Disconnect the modem connector/cable from the mini PCI board ❶ (Figure 5-24).
- 4. Set the modem connector/cable aside.
- 5. Pull away the plastic retention clips on each side of the mini PCI board **2**. The board tilts upward.
- 6. Lift the edge of the board and slide it out of the mini PCI slot at a 45-degree angle ③.



Figure 5-24. Removing the Mini PCI Board

Reverse the above procedure to install the mini PCI board.

5.19 Disk Cell RTC Battery

Disk Cell RTC Battery Spare Part Number Information

Disk cell RTC battery

236359-001

- 1. Prepare the computer for disassembly (Section 5.3) and remove the following components:
 - a. Hinge covers (Section 5.5)
 - b. Keyboard (Section 5.6)
 - c. Display (Section 5.7)
 - d. EMI shield (Section 5.8)
 - e. Top cover (Section 5.9)
 - f. Infrared board (Section 5.15)
 - g. System board (Section 5.16)
- 2. Turn the system board bottom side up with the rear panel facing you.

3. Lift the edge of the RTC battery to disconnect and remove it from its socket (Figure 5-25).



Figure 5-25. Removing the Disk Cell RTC Battery

Reverse the above procedure to install the disk cell RTC battery.

Specifications

Table 6.1			
Computer			
Dimensions			
Height Depth Width	12.2 in 1.3 in 9.8 in	309 mm 34 mm 248 mm	
Weight (with 14.1-inch TFT display and Li ion battery)	5.9 lb	2.7 kg	
Standalone (Battery) Por	wer Requirements		
Nominal operating voltage (Li ion)	14.8 VDC		
voltage (6-cell Li ion)	11.1 VDC		
AC Adapter Power Requ	irements		
Operating voltage Operating current Operating frequency	100 to 240 VAC RMS nominal 1.3 A RMS 50 to 60 Hz AC nominal		
Maximum transient	4/50 kV		
Temperature			
Operating Nonoperating	50° to 95°F -4° to 140°F	10° to 35°C -20° to 60°C	

This chapter provides physical and performance specifications.

Table 6-1Computer (Continued)

Relative Humidity (non condensing)

Operating Nonoperating	10 to 90% relative humidity 5 to 95% relative humidity, 101.6°F/38.7°C Maximum wet bulb temperature	
Altitude (unpressurized)		
Operating Nonoperating	0 to 10,000 ft 0 to 30,000 ft	0 to 3,048 m 0 to 9,144 m
Shock		
Operating Nonoperating	10 G, 11 ms, half sine 60 G, 11 ms, half sine	
Vibration		
Operating	0.5 G zero-to-peak, 10 to 500 Hz, at 0.5 oct/min sweep rate	
Nonoperating	1.0 G, zero-to-peak, 10 to 500 Hz, at 0.5 oct/min sweep rate	

Applicable product safety standards specify thermal limits for plastic surfaces. The computer operates well within this range of temperatures.

Table 6-2 14.1-inch XGA, TFT Display			
Dimensions			
Height	8.42 in	214 mm	
Depth	11.22 in	285 mm	
Width	14.10 in	358 mm	
Number of colors	Up to 262K		
Contrast ratio	180:1		
Brightness	>150 nits typical		
Pixel resolution			
Pitch		0.279 × 0.279 mm	
Format	1024 × 768		
Configuration	RGB vertical stripe		
Backlight	Cold cathode fluorescent, 1 tube		
Character display	80 × 25		
Refresh	60 Hz		
Total Power Consumption	8.0 W		
Table 6-3 Hard Drives

	15 GB	10 GB
User capacity per drive ¹	15.0 GB	10.0 GB
Drive height (with drive frame)	0.37 in/9.5 mm	0.37 in/9.5 mm
Drive width (with drive frame)	2.5 in/63.5 mm	2.5 in/63.5 mm
Interface type	ATA-5	ATA-5
Seek times (typical read, including setting)		
Single track ³ Average ³ Full stroke ³	3.0 ms 13.0 ms 24.0 ms	3.0 ms 13.0 ms 24.0 ms
User addressable sectors ³	29,498,112	19,640,880
Logical configuration		
Cylinders Heads Sectors per track	16,383 16 63	16,683 16 63

Table 6-3Hard Drives (Continued)		
	15 GB	10 GB
Physical configuration		
Cylinders ³ Heads ³ Sectors per track ³ Bytes per sector	25,800 2 398 - 731 512	25,800 2 398 - 731 512
Buffer size ³	512 KBytes	512 KBytes
Disk rotational speed	4200 rpm	4200 rpm
Transfer rate		
Interface max (Mbytes/sec) ² Media (Mbits/sec) ³	100 155 - 286	100 155 - 286
¹ 1 GB = 1,000,000,000 bytes ² System capability may differ.		

³ Actual drive specifications may differ slightly.

Certain restrictions and exclusions apply. Consult the Compaq Customer Support Center for details.

Table 6-4Diskette Drive		
Diskette size	3.5 inch	88 mm
Light	On system	
Height	0.5 in	12.7 mm
Bytes per sector	512	
Sectors per track		
High density Low density	18 (1.44 MB) 9	15 (1.2 MB)
Tracks per side High density Low density	80 80	
Read/write heads	2	
Average seek times		
Track-to-track (high/low) Average (high/low) Settling time Latency average	3 ms 95 ms 15 ms 100 ms	6 ms 174 ms

Table 6-5CD-ROM Drive		
Applicable disk	CD-ROM (Mode 1, 2, and 3) CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Extra Video CD CD-WO (fixed packets only) CD-Bridge	
Center hole diameter	.59 in 15 mm	
Disk diameter	120 mm, 80 m	
Disk thickness	1.2 mm	
Track pitch	1.6 µ	
Access time		
Random Full Stroke	< 150 ms < 300 ms	
Cache buffer	128 KB	
Data transfer rate		
Sustained, 24X Variable Normal PIO Mode 4 (single burst)	2400 KB/sec (150 KB/sec at 1X) 1500 to 3600 KB/sec (10X to 24X) 16.66 KB/sec	
Startup time	< 8 seconds	
Stop time	< 4 seconds	

Table 6-6 DVD-ROM Drive		
Applicable disk	DVD-5, DVD-9, DV CD-ROM (Mode 1 CD Digital Audio CD-XA ready (Mode CD-I ready (Mode CD-R (read only) CD Plus Photo CD (single/r CD-Bridge	'D-10 and 2) de 2, Form 1 and 2) 2, Form 1 and 2) nultisession)
Center hole diameter	.59 in	15 mm
Disk diameter	120 mm, 80 mm	
Disk thickness	1.2 mm	
Track pitch	.74 µ	
Access time		
Random	< 150 ms	
Full Stroke	< 225 ms	
Audio output level		
Lineout	0.7 V rms	
Headphone	none	
Cache buffer	128 KB	
Data transfer rate		
Sustained, 1X DVD rate	150 KB/sec	
Sustained, 16X DVD rate	2400 KB/sec	
Sustained, 4X DVD rate	5520 KB/sec	
Normal IO Mode 4 (single burst)	16.6 MB/sec	
Startup time	< 15 seconds	
Stop time	< 6 seconds	

Table 6-7 AC Adapter

Weight

Power supply (input)

Operating voltage100Operating current1.3Operating frequency range50Maximum transient4/5

100 to 240 VAC RMS Nominal 1.3 A RMS 50 to 60 Hz Nominal 4/50 kV

à-8 acks
21 mm
96 mm
134 mm
.39 kg
17 mm
131 mm
140 mm
40°F 10° to 40°C
40°F -30° to 60°C

Table 6-9 System DMA

Hardware DMA	System Function
DMA0	Available for audio
DMA1	Entertainment audio (default; alternate = DMA0, DMA3, none)
DMA2	Diskette drive
DMA3	ECP parallel port LPT1 (default; alternate = DMA0, none)
DMA4	DMA controller cascading (not available)
DMA5	Available for PC Card
DMA6	not assigned
DMA7	not assigned
PC Card controller can use DMA 1, 2, or 5.	

Table 6-10 System Interrupts

Hardware IRQ	System Function
IRQ0	System timer
IRQ1	Keyboard controller
IRQ2	Cascaded
IRQ3	COM2
IRQ4	COM1
IRQ5	Audio (default)*
IRQ6	Diskette drive
IRQ7	Parallel port
IRQ8	Real time clock (RTC)
IRQ9	Infrared
IRQ10	System use
IRQ11	System use
IRQ12	Internal point stick or external mouse
IRQ13	Coprocessor (not available to any peripheral)
IRQ14	IDE interface (hard drive and optical drive)
IRQ15	System use
PC Cards may assert IRQ3, IRQ4, IRQ5, IRQ7, IRQ9, IRQ10, IRQ11, or IRQ15. Either the infrared or the serial port may assert IRQ3 or IRQ4.	

*Default configuration; audio possible configurations are IRQ5, IRQ7, IRQ9, IRQ10, or none.

Table 6-11 System I/O Addresses

I/O Address (hex)	System Function (shipping configuration)
000 - 00F	DMA controller no. 1
010 - 01F	unused
020 - 021	Interrupt controller no. 1
022 - 024	Opti chipset configuration registers
025 - 03F	unused
02E - 02F	87334 "Super IO" configuration for CPU
040 - 05F	Counter/timer registers
044 - 05F	unused
060	Keyboard controller
061	Port b
062 - 063	unused
064	Keyboard controller
065 - 06F	unused
070 - 071	NMI enable/real time clock
072 - 07F	unused
080 - 08F	DMA page registers
090 - 091	unused
092	Port A
093 - 09F	unused
0A0 - 0A1	Interrupt controller no. 2

Table 6-11
System I/O Addresses (Continued)

I/O Address (hex)	System Function (shipping configuration)
0A2 - 0BF	unused
0C0 - 0DF	DMA controller no. 2
0E0 - 0EF	unused
0F0 - 0F1	Coprocessor busy clear/reset
0F2 - 0FF	unused
100 - 16F	unused
170 - 177	Secondary fixed disk controller
178 - 1EF	unused
1F0 - 1F7	Primary fixed disk controller
1F8 - 200	unused
201	Joystick (decoded in ESS1688)
202 - 21F	unused
220 - 22F	Entertainment audio
230 - 26D	unused
26E - 26	unused
278 - 27F	unused
280 - 2AB	unused
2A0 - 2A7	unused
2A8 - 2E7	unused
2E8 - 2EF	Reserved serial port

Table 6-11 System I/O Addresses (Continued)

I/O Address (hex)	System Function (shipping configuration)
2F0 - 2F7	unused
2F8 - 2FF	Infrared port
300 - 31F	unused
320 - 36F	unused
370 - 377	Secondary diskette drive controller
378 - 37F	Parallel port (LPT1/default)
380 - 387	unused
388 - 38B	FM synthesizer - OPL3
38C - 3AF	unused
3B0 - 3BB	VGA
3BC - 3BF	Reserved (parallel port/no EPP support)
3C0 - 3DF	VGA
3E0 - 3E1	PC Card controller in CPU
3E2 - 3E3	unused
3E8 - 3EF	Internal modem
3F0 - 3F7	"A" diskette controller
3F8 - 3FF	Serial port (COM1/default)
CF8 - CFB	PCI configuration index register (PCIDIVO-1)
CFC - CFF	PCI configuration data register (PCIDIVO-1)

Table 6-12 System Memory Map

Size	Memory Address	System Function
640 K	00000000 - 0009FFFF	Base memory
128 K	000A0000 - 000BFFFF	Video memory
48 K	000C0000 - 000CBFFF	Video BIOS
160 K	000C8000 - 000E7FFF	unused
64 K	000E8000 - 000FFFFF	System BIOS
15 M	00100000 - 00FFFFFF	Extended memory
58 M	01000000 - 047FFFFF	Super extended memory
58 M	04800000 - 07FFFFFF	unused
2 M	08000000 - 080FFFF	Video memory (direct access)
4 G	08200000 - FFFEFFFF	unused
64 K	FFFF0000 - FFFFFFFF	System BIOS

A

Connector Pin Assignments



Table A-3 External Keyboard/Mouse



Pin	Signal	Pin	Signal
1	Keyboard/mouse data1	4	+5 VDC
2	Keyboard/mouse data2	5	Keyboard/mouse clock1
3	Ground	6	Keyboard/mouse clock2

Table A-4 RJ-11 Modem



Pin	Signal	Pin	Signal
1	Unused	4	Unused
2	Tip	5	Unused
3	Ring	6	Unused

Table A-5 RJ-45 Network Interface



Pin	Signal	Pin	Signal
1	Transmit +	5	Unused
2	Transmit -	6	Receive -
3	Receive +	7	Unused
4	Unused	8	Unused

Table A-6	
Universal Serial	Bus

<u>1</u>	2 3	4
<u>1</u> 2	2 3	4

Pin	Signal	Pin	Signal
1	+5 VDC	3	Data +
2	Data -	4	Ground

Table A-7 Serial



Pin	Signal	Pin	Signal
1	Carrier detect	6	Data set ready
2	Receive data	7	Ready to send
3	Transmit data	8	Clear to send
4	Data terminal ready	9	Ring indicator
5	Signal ground		

Table A-8 External Monitor



Pin	Signal	Pin	Signal
1	Red analog	9	+5 VDC
2	Green analog	10	Ground
3	Blue analog	11	Monitor detect
4	Not connected	12	DDC 2B data
5	Ground	13	Horizontal sync
6	Ground analog	14	Vertical sync
7	Ground analog	15	DDC2B clock
8	Ground analog		

Table A-9 Parallel



Pin	Signal	Pin	Signal	
1	Strobe*	10	Acknowledge*	
2	Data bit 0	11	Busy	
3	Data bit 1	12	Paper out	
4	Data bit 2	13	Select	
5	Data bit 3	14	Auto line feed*	
6	Data bit 4	15	Error*	
7	Data bit 5	16	Initialize printer*	
8	Data bit 6	17	Select in*	
9	Data bit 7	18-25	Signal ground	
*Signal is active low.				

B

Power Cord Set Requirements

3-Conductor Power Cord Set

The computer's wide range input feature permits it to operate from any line voltage from 100 to 120 or 220 to 240 volts AC.

The power cord set received with the computer meets the requirements for use in the country where the equipment is purchased.

Power cord sets for use in other countries must meet the requirements of the country where the computer is used. For more information on power cord set requirements, contact a Compaq authorized reseller or service provider.

General Requirements

The requirements listed below are applicable to all countries:

- The length of the power cord set must be at least 5.00 feet (1.5 m) and a maximum of 6.50 feet (2.0 m).
- All power cord sets must be approved by an acceptable accredited agency responsible for evaluation in the country where the power cord set will be used.
- The power cord set must have a minimum current capacity of 10A and a nominal voltage rating of 125 or 250 volts AC, as required by each country's power system.
- The appliance coupler must meet the mechanical configuration of an EN 60 320/IEC 320 Standard Sheet C13 connector, for mating with appliance inlet on the back of the computer.

Country-Specific Requirements

3-Conductor Power Cord Set Requirements—By Country			
Country	Accredited Agency	Applicable Note Number	
Australia	EANSW	1	
Austria	OVE	1	
Belgium	CEBC	1	
Canada	CSA	2	
Denmark	DEMKO	1	
Finland	FIMKO	1	
France	UTE	1	
Germany	VDE	1	
Italy	IMQ	1	
Japan	METI	3	
The Netherlands	KEMA	1	
Norway	NEMKO	1	
Sweden	SEMKO	1	
Switzerland	SEV	1	
United Kingdom	BSI	1	
United States	UL	2	

Notes

1. The flexible cord must be <HAR> Type HO5VV-F, 3-conductor, 1.0 mm² conductor size. Power cord set fittings (appliance coupler and wall plug) must bear the certification mark of the agency responsible for evaluation in the country where it will be used.

- 2. The flexible cord must be Type SPT-3 or equivalent, No. 18 AWG, 3-conductor. The wall plug must be a two-pole grounding type with a NEMA 5-15P (15A, 125V) or NEMA 6-15P (15A, 250V) configuration.
- 3. The appliance coupler, flexible cord, and wall plug must bear a "T" mark and registration number in accordance with the Japanese Dentori Law. The flexible cord must be Type VCT or VCTF, 3-conductor, 1.00mm² conductor size. The wall plug must be a two-pole grounding type with a Japanese Industrial Standard C8303 (7A, 125V) configuration.

С

Screw Listing

This appendix provides specification and reference information for the screws used in the computer. All screws listed in this appendix are available in the Miscellaneous Screw Kit, spare part number 239042-001.

Table C-1M2.5 × 7.0 Screw								
Color Qty Length Thread								
	Pewter	14	7.0 mm	M2.5	4.0 mm			
Where used: 2 screws se Section 5.6)	curing the key	/board	to the top c	over (docu	mented in			



Table C-1 M2.5 × 7.0 Screw <i>(Continued)</i>								
H Color Qty Length Thread W								
	Pewter	14	7.0 mm	M2.5	4.0 mm			
Where used: 9 screws s (documented in Section !	ecuring the top 5.9)	cover	to the base	enclosure				





Table C-1M2.5 × 7.0 Screw (Continued)								
۲ Color Qty Length Thread V								
	Pewter	14	7.0 mm	M2.5	4.0 mm			
Where used: 2 screws see (documented in Section 5.	curing the top 9)	cover	to the base	enclosure				



Table C-1M2.5 × 7.0 Screw (Continued)							
Color Qty Length Thread							
	Pewter	14	7.0 mm	M2.5	4.0 mm		
Where used: 1 screw se in Section 5.14)	curing the heat	sink to	the system	n board (do	cumented		



Table C-2 M2.5 × 8.0 Screw

	Color	Qty	Length	Thread	Head Width
	Silver	4	8.0 mm	M2.5	5.0 mm
Where used: 4 screws securir (documented in Section 5.7)	ng the dis	play to	the base e	nclosure	



Table C-3 M2 × 5.5 Screw Image: Color Qty Length Thread Width								
Where used: 1 screw in enclosure (documented	the battery bay in Section 5.9)	y securi	ng the top	cover to the	base			



Table C-4 M2.5 × 4.5 Screw								
Head Color Qty Length Thread Width								
	Black	11	4.5 mm	M2.5	4.0 mm			
Where used:								

• 2 screws securing the hard drive to the base enclosure (Refer to the *Hardware Guide* shipped with the computer for installation information.)

9 5 screws securing the top cover to the base enclosure (documented in Section 5.9)



M2.5 × 4.5 Screw (Continued)								
🐨 Color Qty Length Thread								
	Black	11	4.5 mm	M2.5	4.0 mm			

Where used:

1 screw securing the top cover to the base enclosure (documented in Section 5.9)



M2.5 × 4.5 Screw <i>(Continued)</i>									
~	🐨 Color Qty Length Thread								
	Black	11	4.5 mm	M2.5	4.0 mm				
Where used:									

. . .

1 screw near the USB connector securing the system board to the base enclosure (documented in Section 5.16)



M2.5 × 4.5 Screw (Continued)									
~~	Color	Qty	Length	Thread	Head Width				
	Black	11	4.5 mm	M2.5	4.0 mm				
Where used:									

Table C-4

2 screws securing the top cover shield to the top cover; must be removed in order to remove the right speaker (documented in Section 5.11)



Table C-5 M2 × 12.5							
Color	Qty	Length	Thread	Head Width			
Black	1	12.5 mm	M2	4.5 mm			

Where used:

1 screw securing the EMI shield to the base enclosure (documented in Section 5.8)



Table C-6 M2.5 × 4.0 Screw								
Head We Color Qty Length Thread Width								
	Black	4	4.0 mm	M2.5	4.0 mm			
Where used: 3 screws s (documented in Section	ecuring the To	uchPad	bracket to	the top cov	er			



Table C-6M2.5 × 4.0 Screw (Continued)					
•	Color	Qty	Length	Thread	Head Width
	Black	4	4.0 mm	M2.5	4.0 mm
Where used:					

1 screw securing the modem connector/cable to the base enclosure (documented in Section 5.16)


Table C-7 M2.5 × 3.0 Screw								
(@)	Color	Qty	Length	Thread	Head Width			
	Silver	2	3.0 mm	2.5 mm	3.0 mm			
Where used								

ere usea:

2 screws securing the TouchPad bracket to the top cover (documented in Section 5.10)



Table C-8M2 × 6.0 Screw							
	Color	Qty	Length	Thread	Head Width		
	Silver	8	6.0 mm	M2	3.0 mm		
Where used: 8 screws s Section 5.11)	ecuring the sp	eakers	to the top c	over (docu	mented in		



Table C-9 M1 × 4.0 Screw								
~	Color	Qty	Length	Thread	Head Width			
	Silver	1	4.0 mm	M1	3.0 mm			
Where used:								

1 screw securing the display lid switch board to the top cover (documented in Section 5.13)



Table C-10M2 × 4.0 Screw								
He Color Qty Length Thread Wi								
	Black	8	4.0 mm	M2	4.5 mm			
Where used								

Where used:

2 screws securing the memory expansion compartment cover to the base enclosure (Refer to the *Hardware Guide* shipped with the computer for memory installation information.)



Table C-10M2 × 4.0 Screw (Continued)								
•	Color	Qty	Length	Thread	Head Width			
	Black	8	4.0 mm	M2	4.5 mm			

Where used:

• 4 screws securing the heat sink to the system board (documented in Section 5.14)

 1 screw securing the infrared board to the base enclosure (documented in Section 5.15)

 I screw near the display connector securing the system board to the base enclosure (documented in Section 5.16)



Table C-11 M2 × 14.5 Screw					
Color	Qty	Length	Thread	Head Width	
Black	2	14.5 mm	M2	3.0 mm	

Where used:

2 screws securing the system board to the base enclosure (documented in Section 5.16)



Table C-12 M2 × 5.0 Screw								
and the second s	Color	Qty	Length	Thread	Head Width			
	Silver	2	5.0 mm	2.0 mm	4.0 mm			
Where used								

wnere used:

2 screws securing the PC Card assembly to the system board (documented in Section 5.17)



Table C-13 5.0 mm Screwlock

Color	Qty	Length	Socket	Head Width
 Silver	6	9.0 mm	5.0 mm	n/a

Where used:

6 screwlocks securing the system board to the base enclosure (documented in Section 5.16)



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